



ADVANCED INFORMATION

MX98748

Highly Integated 10/100M Dual Speed Hub With Extra 4 Port Switch Built-In

1. Features

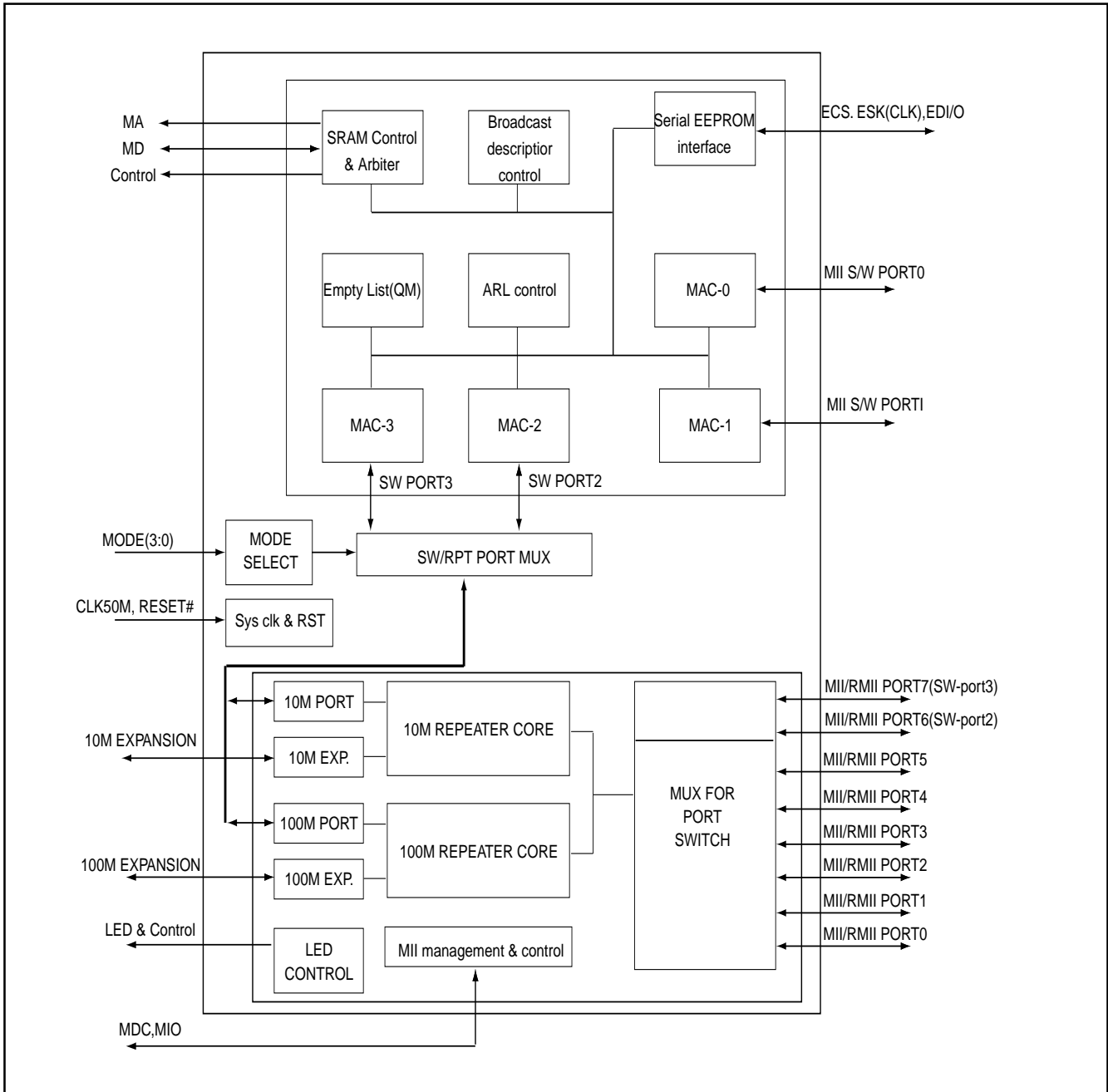
- Integrate a 4-port switch core and a 12-port dual-speed repeater core.
- Support 0 to 4 MII switch ports and 6 to 8 MII/RMII repeater ports and 10/100M expansion ports. Configure by MODE select.
- Each switch port can operate in 10/100, half/full duplex mode, auto-configured by a N-way PHYceiver.
- Each repeater port auto-sense line speed (10/100M), and operate in half-duplex mode.
- Provide 10M and 100M Expansion Buses for stacking up to 9 Hubs.
- Provide Link/Activity, Partition, Utilization LED display function for diagnostic purpose.
- The embedded switch operates in Store-and-forward mode
- Support up to 2K address entries without external address look-up IC
- Single 64Kx32 SSRAM part used as data buffering and filtering database for the embedded switch.
- IEEE802.3X flow control for full-duplex switch port.
- Backpressure flow control for half-duplex switch port.
- Provide RX-Buffer-Threshold control and TX-Buffer-Threshold control to avoid any port occupying all buffer resource.
- Support serial EEPROM interface for power on configuration

2. General Description

The MX98748 is a Fast Ethernet product with 4 port switch and 8 port repeater hub controller. By MODE select, it can offer different type of switch and hub port configuration such as 2SW/8HUBport, 3SW/7HUB port, 4SW/6HUB port separately. Combine with MX98747 - 8 Ports dual speed repeater controller, customer can design di-

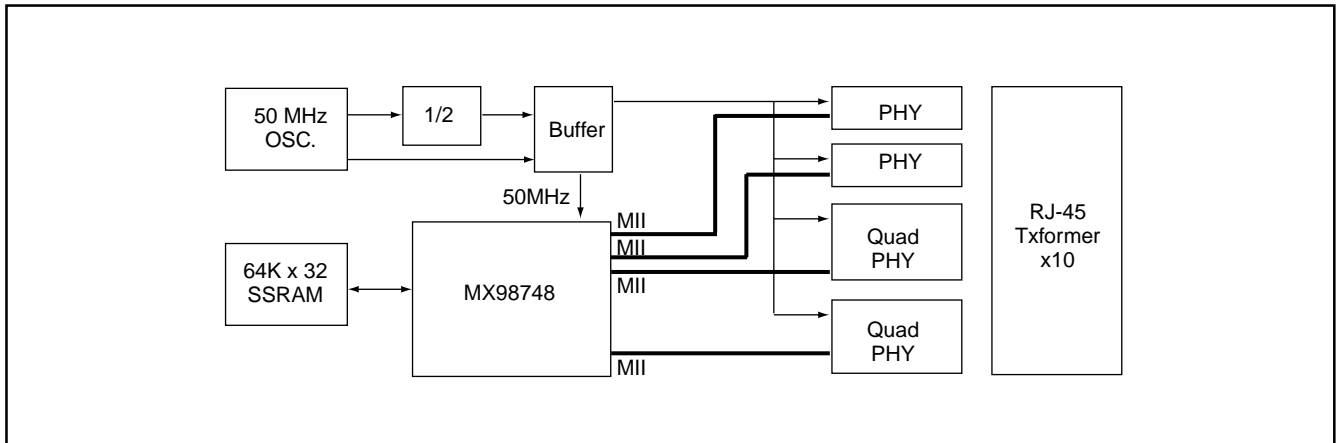
verse hibrid hub (hub with switch function) products such as 16rpt port + 2 switch ports, 24rpt port + 2 switch ports, and etc.(more information on application configuration can be found in application note and MX98748 presentation material.)

3.0 Block Diagram

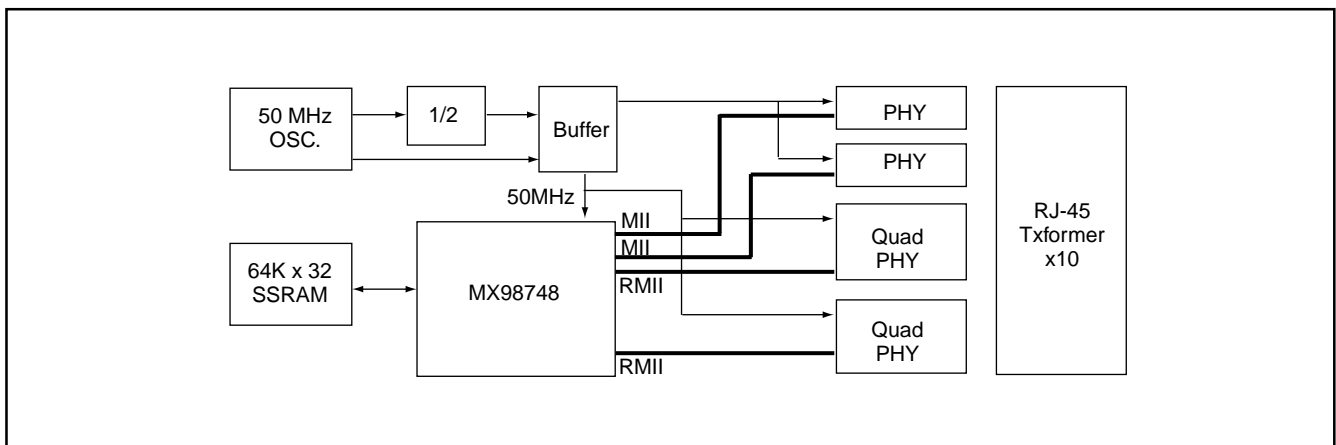


3.1 Typical Application

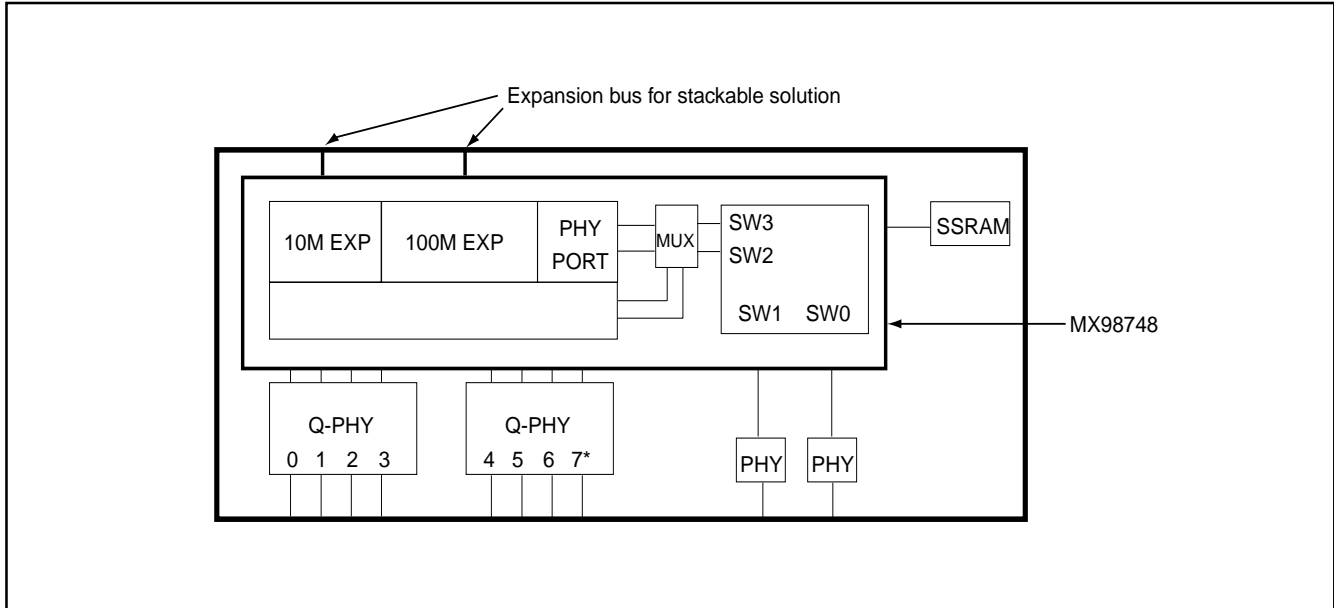
MII Interface:

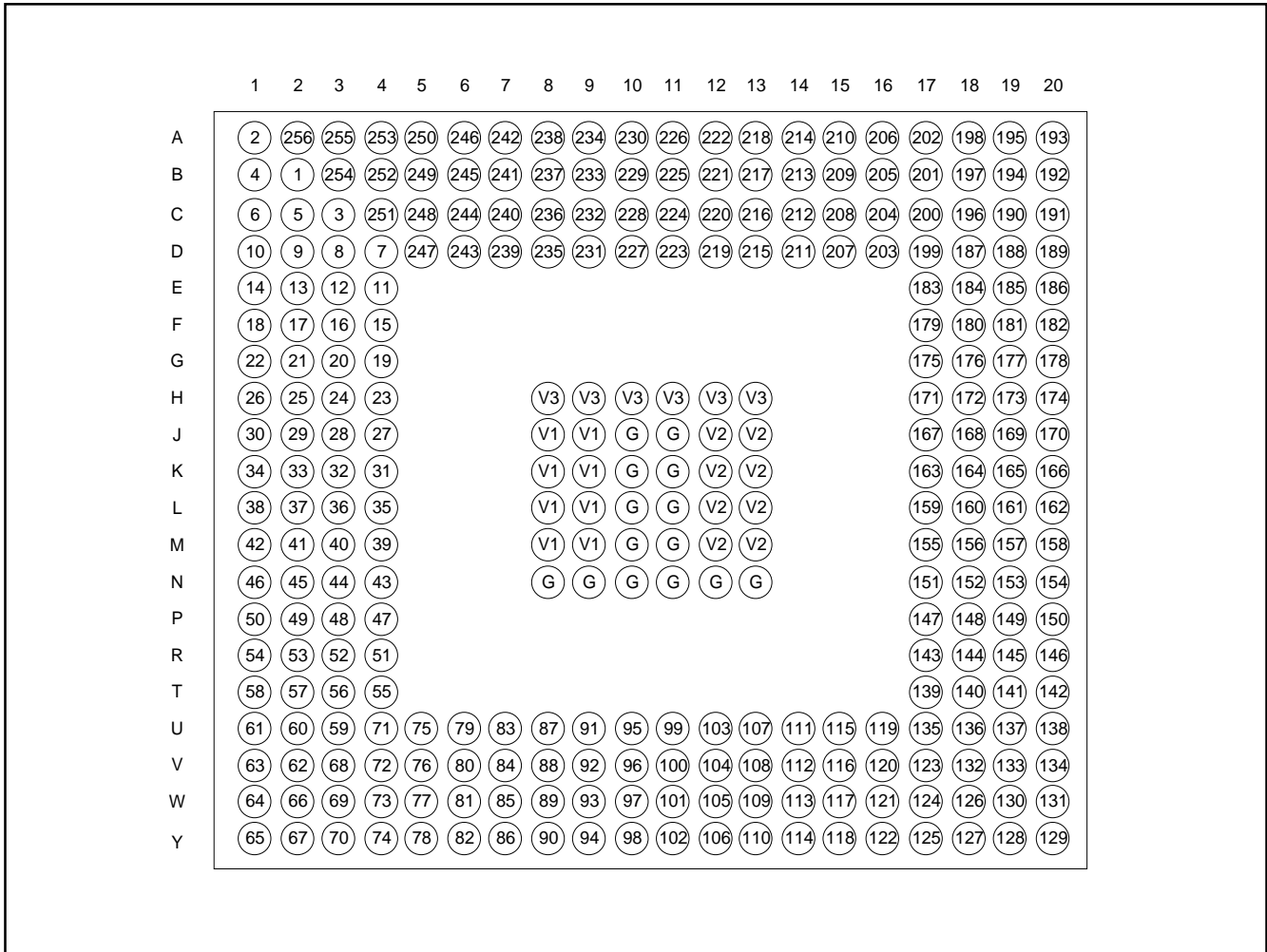


RMII Interface:



4.0 System Implementation Block Diagram



5.0 Pin Configuration


6.0 Pin description

A. Switch MII Port, 35 pins

Pin NAME	PIN TYPE	BGA #	Description
S1TXD[3:0]	O, 4mA	159-162	Switch MII Transmit Data.
S2TXD[3:0]		95-98	
S1TXEN	O, 4mA	171	Switch MII Transmit Enable.
S2TXEN		106	
S1TXCLK	I, TTL, DN	172	Switch MII Transmit Clock.
S2TXCLK		107	
S1CRS	I, TTL, DN	157	Switch MII Carrier Sense.
S2CRS		93	
S1RXDV	I, TTL, DN	175	Switch MII Receive Data Valid.
S2RXDV		110	
S1COL	I, TTL, DN	158	Switch MII Collision Input. High if network has collision. S3COL input from LINK[6] in mode (1100,1101)
S2COL		94	
S4COL		138	
S1RXCLK	I, TTL, DN	174	Switch MII Receive Clock.
S2RXCLK		109	
S1RXD[3:0]	I, TTL, DN	179-176	Switch MII 4B Receive Data.
S2RXD[3:0]		114-111	
S1RXER	I, TTL, DN	173	Switch MII Receive Error.
S2RXER		108	
DUPLEX1	I, TTL, DN	140	Switch MII Duplex Input. High for half duplex, low for full duplex. And this polarity can be change by register 0.8. DUPLEX3 input from LINK[7] in mode(1100,1101)
DUPLEX2		141	
DUPLEX4		139	
LSWBUFF	O, 16mA	126	Switch SSRAM Buffer Full LED Output. Low active. Active when the buffer is full.

B. Switch SSRAM Interface, 50 pins

Pin NAME	PIN TYPE	BGA #	Description
MA[15:0]	O, 4mA	210-217	Switch SSRAM Address Outputs.
		225-232	
MD[31:0]	I/O,TTL,4mA	38-31	Switch SSRAM Data I/O.
		26-19	
		7-256	
		246-240	
GWX	O, 8mA	202	Switch SSRAM Write Enable. (Low active)
CEX	O, 8mA	204	Switch SSRAM Chip Enable. (Low active)

C. EEPROM Interface, 6 pins

Pin NAME	PIN TYPE	BGA #	Description
ECS/TEST0	I/O,TTL,4mA	122	EEPROM Chip Select. Input for test mode selection when RESETL active.
ESK/TEST1	I/O,TTL,4mA	123	EEPROM Clock. Input for test mode selection when RESETL active.
EDI/TEST2	I/O,TTL,4mA	124	EEPROM Data In. Input for test mode selection when RESETL active.
EDO	I/O,TTL,4mA	125	EEPROM Data Output.
EEPROM	I,TTL	203	High for EEPROM Present.
EEMASTER	I,TTL	163	EEPROM Master. If high, MX98748 will work as the master of EEPROM interface; if low, it will work in slave mode of EEPROM interface.

Note:(TEST0, TEST1, TEST2)=(0,0,0) in normal operation.

**D. Repeater Hub MII/RMII Port, 120 pins**

Pin NAME	PIN TYPE	BGA #	Description
TXD0[3:0]	O,4mA	253-255,8	Repeater Transmit Data. Port7 ~ Port0
TXD1[3:0]		28-30,39	
TXD2[3:0]		50-53	
TXD3[3:0]		65-68	
TXD4[3:0]		80-83	
TXD5[3:0]		100-103	
TXD6[3:0]		165-168	
TXD7[3:0]		189-192	
TXEN[7:0]	O,4mA	193,169,104, 84, 69, 54, 40, 9	Repeater Transmit Enable.
TXCLK[7:0]	I,TTL	194,170,105, 85, 70, 55, 41, 10	Repeater Transmit Clock.
LINK[7:0]	I,TTL	137, 136, 133, 128,78, 56, 127, 18	Repeater Link Good. Low for link good. If high over 192ms, a link fail will detect.
CRS[7:0]	I,TTL	188, 164, 99, 79, 64, 49, 27, 252	Repeater Carrier Sense.
RXDV[7:0]	I,TTL	197, 183, 117, 88,73, 59, 44, 13	Repeater Receive Data Valid. Also speed input in RMII mode, low for speed 100M.
RXCLK[7:0]	I,TTL	196, 182, 116, 87, 72, 58, 43, 12	Repeater Receive Clock.
RXER[7:0]	I,TTL	195, 181, 115, 86, 71, 57, 42, 11	Repeater Receive Error. If true, a jam pattern will send out through that packet.
RXD0[3:0]	I,TTL	17-14	Repeater Receive Data. Port7 ~ Port0
RXD1[3:0]		48-45	
RXD2[3:0]		63-60	
RXD3[3:0]		77-74	
RXD4[3:0]		92-89	
RXD5[3:0]		121-118	
RXD6[3:0]		150-147	
RXD7[3:0]		165-162	



E. Repeater Hub LED & Control, 14 pins

Pin NAME	PIN TYPE	BGA #	Description												
LEDINF[7:0]	I/O,TTL,16mA	142-150	Repeater LED Information Output (Normal Mode).In SCAN mode, LEDINF output 10/100M core state information. In power on jumper mode, set each port control register. LNKACTSEL PARSEL												
			<table border="1"> <tr> <td>0</td> <td>0</td> <td>----Normal</td> </tr> <tr> <td>0</td> <td>1</td> <td>----Partition Disable</td> </tr> <tr> <td>1</td> <td>0</td> <td>----Jabber Disable</td> </tr> <tr> <td>1</td> <td>1</td> <td>----Speed Set</td> </tr> </table>	0	0	----Normal	0	1	----Partition Disable	1	0	----Jabber Disable	1	1	----Speed Set
0	0	----Normal													
0	1	----Partition Disable													
1	0	----Jabber Disable													
1	1	----Speed Set													
LED10COL	O,16mA	135	Repeater 10M Collision LED Output. Low active Also it is 10M core state jam or quiet indicator in SCAN mode.												
LED100COL	O,16mA	134	Repeater 100M Collision LED Output. Low active.Also it is 100M core state jam or quiet indicator in SCAN mode.												
LNKACTSEL	I/O,TTL,4mA	132	Repeater LEDINF Link/Act Rising Latch Clock (Normal Mode) Also power on jumper mode setting, see LEDINF.												
PARSEL	I/O,TTL,4mA	131	Repeater LEDINF Partition Rising Latch Clock (Normal Mode). Also power on jumper mode setting, see LEDINF.												
UTL10SEL	I/O,TTL,4mA	130	Repeater LEDINF 10M Utilization Rising Latch Clock (Normal Mode). In SCAN mode, 10M state output Error/Idle indicator. Power on jam extension jumper mode setting.												
UTL100SEL	I/O, TTL, 4mA	129	Repeater LEDINF 100M Utilization Rising Latch Clock (Normal Mode). In SCAN mode, 100M state output Error/Idle indicator. Power on jam extension jumper mode setting.												

**F. 10/100M Expansion Port, 22 pins**

Pin NAME	PIN TYPE	BGA #	Description
JAMO10	O, 8mA	235	Forced Jam Out. Active High. The pin is asserted upon collision detected or receive error.
JAMO100		207	
JAMI10	I,TTL,Schm	236	Forced Jam Input. Active High. Assert when other stacked hub detected a collision.
JAMI100		208	
EPCLK10	I/O,TTL,DN,8mA	238	Expansion port Data Clock. Use as receive or transmit expansion port clock.
EPCLK100		219	
ERXDV10	I/O,TTL,DN,8mA	239	Expansion Port Data Valid.
ERXDV100		220	
E10DAT[3:0]	I/O,TTL,DN,8mA	224-221	Expansion Port 4B Data.
E100DAT[3:0]		251-248	
ANYACT10	O,8mA	234	Any Activity. Active high. A OR function result of CRS[7:0]. to tell other stacked hubs there are activities. To other stacked hub's EDCRS.
ANYACT100		206	
EDCRS10	I,TTL,Schm	237	Expansion Data Carrier Sense. Active high, other stacked hubs' activities will pass on this pin.
EDCRS100		218	
EDACT10	O,8mA	233	Expansion Data Activity. System application use this pin to control data flow of EDAT, ERXDV, EPCLK.
EDACT100		205	



G. Management Interface & Miscellaneous, 9 pins

Pin NAME	PIN TYPE	BGA #	Desvription
MDC	I/O,TTL,DN,4mA	151	Management Data Clock.
MDIO	I/O,TTL,UP,4mA	150	Management Data Input/Output.
MODE[3:0]	I,TTL,DN	155-152	MODE Select. Define MX98748 function 0000 NORMAL - 2SW + 8MII Hub Ports 0001 SCAN - Hub Scan for Debug Use 0010 SW2RMII - 2SW + 8RMII Hub Ports 0011 FMODE - Hub High Speed Test Mode 0110 SW4D10R- 3SW + 7RMII Hub Ports, internal 10M link disable 0111 SW4D10- 3SW + 7MII Hub Ports, internal 10M link disable 1010 SW3D100R - 3SW + 7RMII Hub Ports, internal 100M link disable 1011 SW3D100 - 3SW + 7RMII Hub Ports, internal 100M link disable 1100 SW4 - 4SW 6MII Hub Ports with no internal link 1101 SW4R - 4SW 6RMII Hub Ports with no internal link 1110 - Test only 1111 - Test only
RESETL	I,TTL,Schm	156	Reset Bar Input. Low active. Must last more than 160ns.
CLK50M	I,TTL,Schm	180	Chip 50MHz Clock Input.
ALL100	Tri-state	209	If any repeater port in the Hub is connected to 10 Base, the pin will assert low, otherwise it will keep in High-Z state.

H. Power & Ground, 34 pins

Pin NAME	PIN TYPE	BGA #	Desvription
VDD = 3.3V	I	In Center V1 Ball	Power.
GND	I	In Center G Ball	Ground.

7.0 FUNCTIONAL DESCRIPTION

The MX98748 is operating by a single 50MHz clock frequency.

The MX98748 is a chip integrated with the 4-port switch and the 12-port repeater. MODE[3:0] determines the major chip function whether it is a 2SW/8Hub, 3SW/7Hub, 4SW/6 Hub Ports. MODE[3:0] also determines MII or RMII interface functions.

Each switch port can operate in 10/100M, half/full duplex mode. auto-configured by N-Way PHYceiver.

Each repeater port auto-detect line speed (10/100M), operate in half-duplex mode.

The repeater also equipped with 10/100M expansion port for stackable solution. 9 hubs can be stacked through the expansion bus architecture.

The MII management interface can program Seeq 84225 Quad PHY into half duplex repeater mode after power on for hub application. One can also force The MX98748 internal register for each repeater port to control port behavior.

The LED interface provide Link/Activity, Partition, Utilization function diaplay of repeater hub.

7.1 Mode seting

The MX98748 function is determined by MODE[3:0] as shown table below:

Mode Name	MODE[3:0]	Function Description
NORMAL	0000	Normal mode, 2 SW + 8 MII Hub Ports
SCAN	0001	Test only
SW2RMII	0010	2 SW + 8 RMII Hub ports
FMODE	0011	Test only
-	0100	Reserve
-	0101	Reserve
SW4D10R	0110	3 SW + 7 RMII Hub port, Hub port 7 = SW4,internal 10M Link disable
SW4D10	0111	3 SW + 7 MII Hub port, Hub port 7 = SW4,internal 10M Link disable
-	1000	Reserve
-	1001	Reserve
SW3D100R	1010	3 SW + 7 RMII Hub port, Hub port 6 = SW3,internal 100M Link disable
SW3D100	1011	3 SW + 7 MII Hub port, Hub port 6 = SW3,internal 100M Link disable
SEPERATE	1100	Seperate 4 SW and 6 MII Hub Ports
SEP_RMII	1101	Seperate 4 SW and 6 RMII Hub Ports
TEST	1110	Test only
TEST	1111	Test only

When chip is under normal mode operation, there are extra 2 SW ports and 8 MII repeater ports from the application view point.

Under SW2RMII, same as NORMAL except hub port is RMII interface.

SW4D10R: Disable10M phy mode link between switch and hub core internally. Hub port 7 becomes Swtich port 4. Hub port 0-6 are RMII interface.

SW4D10: The same as SW4D10R except Hub port 0-6 are MII interface.

SW3D100R: Disable 100M phy mode link between switch and hub core internally. Hub port 6 becomes Switch port 3. Hub port 0-5, 7 are RMII interface.

SW3D100: The same as SW3D100R except Hub port 0-5, 7 are MII interface.

SEPERATE mode, there is no data link between switch and hub core. Hub port 6, 7 become SW3 & SW4. The chip functions 4 switch ports and 6 hub ports. LINK[6] is S3COL, LINK[7] is DUPLEX3.

SEP_RMII: The same as SEPERATE, except 6 hub ports are RMII interface.

7.2 EEPROM pin function description

EEPROM = true means EEPROM device present.

7.3 Port function jumper mode description

Each port will set its port behavior depends on two control pin by power on latch.

LNKACTSEL	PARSEL	Function Description
0	0	Normal
0	1	Partition Disable
1	0	Jabber Disable
1	1	Speed Set. True=100M

7.4 End of Jam extension jumper mode description

End of jam extension can be alter by power on jumper setting.

UTL10SEL	UTL100SEL	Function Description
0	0	Extend 15 nibbles
0	1	Extend 0 nibbles
1	0	Extend 10 nibbles
1	1	Extend 20 nibbles

7.5 Switch function description

Four ports switch are built-in on the MX98748. The unique features make the MX98748 can be easily used in dual speed HUB application. Two of the 4-PORTS switch are used internally to connect 10M segment and 100M segment. Another extra two switch ports make the application of the chip diversely.

Four ported fast ethernet switch controller is embedded. The switchcore includes MAC protocol, address resolution logic, buffer management and SSRAM controller.

The MAC block supports store-and-forward mode. Both Full Duplex Flow Control 802.3x and JAM based flow control are supported. The transmit and receive buffer's threshold is programmable to avoid only port occupying all buffer resource.

The Address Resolution Logic functions for Address look up, learning, and aging. The address table is in external SSRAM and contains four layer of hash table.

The buffer management includes Broadcast descriptor and Empty List(QM). Each has several descriptors for management.

The SSRAM controller functions as follows. Buffer memory is a 64K*32 SSRAM. The higher memory is used for address resolution table. The others are partitioned into 256 bytes/page for data and descriptor. Each packet may use 1~6 page depends on packet size. Each descriptor page includes 16 descriptors.

memory size	page size	ARL	No. of page
64K*32	256Byte	2K entries	960

7.5 Internal Register Function Description

The internal register are addressed by the following address:

0x10 * (~EEMASTER) + offset
 offset is between 0x0 and 0xf.

7.5.1 Internal Register Format

Offset	Description	Default
0000(0x0)	Configuration Register	0x1c00
0001(0x1)	Aging Time. 10sec/per count	0x001e
0010(0x2)	Flow Control Pause Counter	0x01ff
0011(0x3)	MAC ID [15:0] for Flow Control	0x0000
0100(0x4)	MAC ID [31:16] for Flow Control	0x0000
0101(0x5)	MAC ID [47:32] for Flow Control	0x0000
0110(0x6)	Port 0 Receive Buffer threshold	0x0200
0111(0x7)	Port 1 Receive Buffer threshold	0x0200
1000(0x8)	Port 2 Receive Buffer threshold	0x0200
1001(0x9)	Port 3 Receive Buffer threshold	0x0200
1010(0xa)	TxThresh Enable / Port 0 Transmit Buffer threshold	0x2300
1011(0xb)	TxThresh Enable / Port 1 Transmit Buffer threshold	0x2300
1100(0xc)	TxThresh Enable / Port 2 Transmit Buffer threshold	0x2300
1101(0xd)	TxThresh Enable / Port 3 Transmit Buffer threshold	0x2300
1110(0xe)	Multicast Buffer threshold	0x2300

7.5.2 Internal Register Description

7.5.2.1 Configuration Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	MIM	C16D	FCE	Hash	R	DP	BPN	AbortCnt	MBZ						

Default: 0x1c00

Bit 3:0 : MBZ : Must Be Zero "0000"

Bit 5:4 : AbortCnt : Define the packets may be received after recive threshold is over.

- 00 : Can Receive 8 good Packets after Receive threshold over
- 01 : Can Receive 16 good packets after Receive threshold over
- 10 : Can Receive 32 good packets after Receive threshold over
- 11 : All good packets will be Received after Receive threshold over

Bit 7:6 : BPN : Define the Back-Pressure-Number of jamming the coming packets.

- 00 : Back Pressure Count = 8
- 01 : Back Pressure Count = 16
- 10 : Back Pressure Count = 32
- 11 : Back Pressure Count = Infinite

Bit 8 : Duplex polarity : 1 : Input pin Duplex High -> Full, Low -> Half
0 : Input pin Duplex Low -> Full, High -> Half

Bit 9 : Reserved

Bit 11:10 : Hash bits select. 0 : Hash bits = CRC bit 12:4
 1 : Hash bits = CRC bit 18:10
 2 : Hash bits = CRC bit 25:17
 3 : Hash bits = CRC bit 31:23

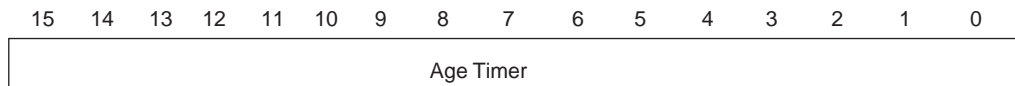
Bit 12 : Full Duplex Flow Control Enable, high active.

Bit 13 : Collision-16 Disable, high active.

Bit 14 : Management Interface Master Enable, high active.

Bit 15 : Reserved

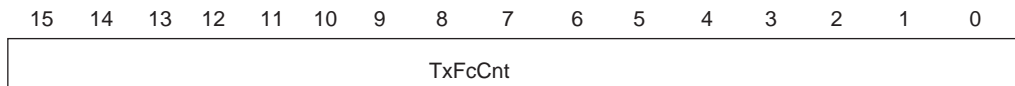
7.5.2.2 Ageing timer



Default : 0x001e

Bit 0:15 : AgeTimer : Ageing Timer 10 sec/per count

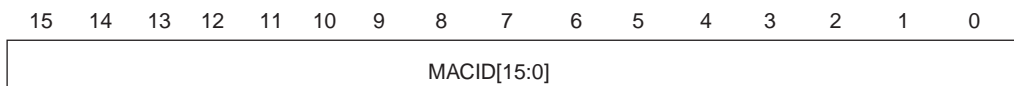
7.5.2.3 Flow Control Pause Time



Default: 0x01ff

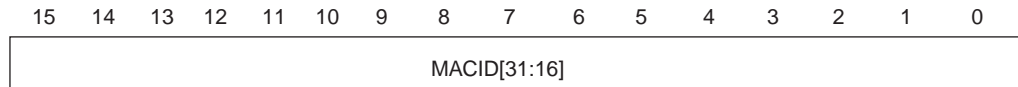
Bit 0:15: TxFcCnt : Flow Control Pause Time

7.5.2.4 MAC ID [15:0] for Flow Control



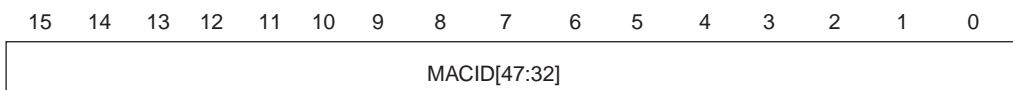
Default: 0x0000

Bit 0:15: MACID[15:0] : MAC ID for Flow Control

7.5.2.5 MAC ID [31:16] for Flow Control

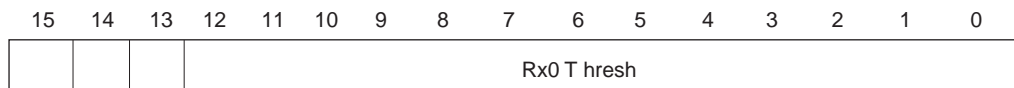
Default: 0x0000

Bit 0:15: MACID[31:16] : MAC ID for Flow Control

7.5.2.6 MAC ID [47:32] for Flow Control

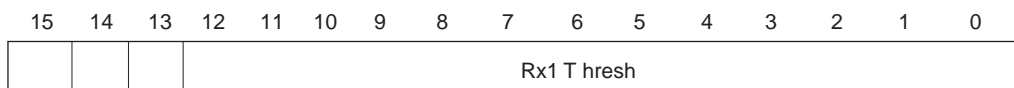
Default: 0x0000

Bit 0:15: MACID[47:32] : MAC ID for Flow Control

7.5.2.7 Port 0 Receive buffer threshold

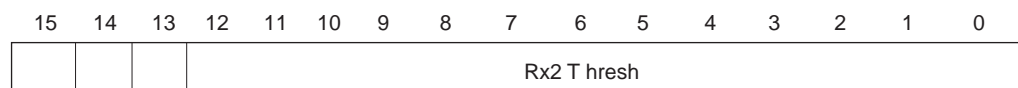
Default: 0x0200

Bit 0:12 : Rx0Thresh : Port 0 Receive buffer threshold.

7.5.2.8 Port 1 Receive buffer threshold

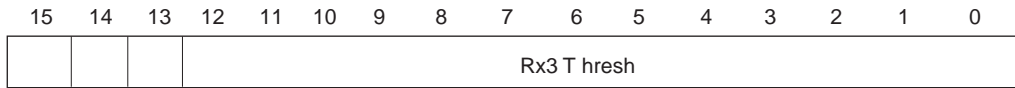
Default: 0x0200

Bit 0:12 : Rx1Thresh : Port 1 Receive buffer threshold.

7.5.2.9 Port 2 Receive buffer threshold

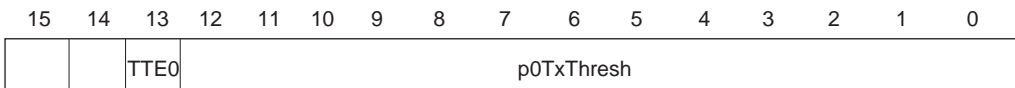
Default: 0x0200

Bit 0:12 : Rx2Thresh : Port 2 Receive buffer threshold.

7.5.2.10 Port 3 Receive buffer threshold


Default: 0x0200

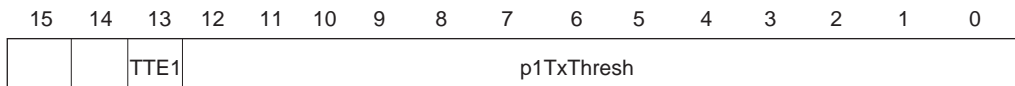
Bit 0:12 : Rx3Thresh : Port 3 Receive buffer threshold.

7.5.2.11 Port 0 Transmit buffer Threshold and transmit threshold enable


Default: 0x2300

Bit 0:12 : p0TxThresh : Port 0 Transmit buffer Thresh.

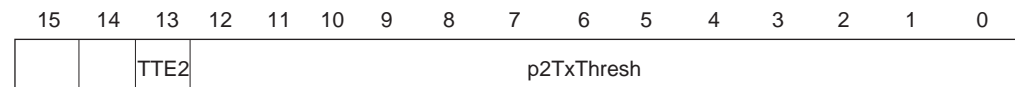
Bit 13 : TTE0 : Port 0 Transmit Threshold Enable

7.5.2.12 Port 1 Transmit buffer Threshold and transmit threshold enable


Default: 0x2300

Bit 0:12 : p1TxThresh : Port 1 Transmit buffer Thresh.

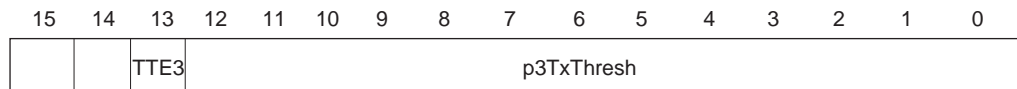
Bit 13 : TTE1 : Port 1 Transmit Threshold Enable

7.5.2.13 Port 2 Transmit buffer Threshold and transmit threshold enable


Default: 0x2300

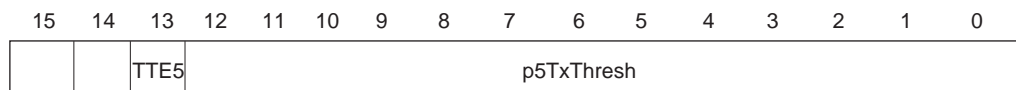
Bit 0:12 : p2TxThresh : Port 2 Transmit buffer Thresh.

Bit 13 : TTE2 : Port 2 Transmit Threshold Enable

7.5.2.14 Port 3 Transmit buffer Threshold and transmit threshold enable

Bit 0:12 : p3TxThresh : Port 3 Transmit buffer Thresh.

Bit 13 : TTE3 : Port 3 Transmit Threshold Enable

7.5.2.15 Port 4 Transmit buffer Threshold and transmit threshold enable

Bit 0:12 : mTxThresh : Multicast Transmit buffer Thresh.

Bit 13 : TTE5 : Multicast Transmit Threshold Enable

8.0 ABSOLUTE MAXIMUM OPERATION RATING

RATING	VALUE
Supply Volatge(VCC)	3.0V to 4.0V
DC Input Voltage(Vin)	-0.3V to VCC+0.3V
DC Output Voltage (Vout)	-0.3V to VCC+0.3V
Storage Temperature Range(TSTG)	-55°C to 150°C
Power Dissipation(PD)	800mW
ESD rating(Rzap=1.5K, Czap=100pF)	2000V

Absolute Maximum Rating for MX98748

Notice:

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cauaese permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended period may affect reliability.

9.0 AC/DC CHARACTERISTIC

A. Supply Current

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
ICC	Average Active(TXing/RXing) Supply Current	X1=50MHz VIN=Switching	-	-	mA
ICCIDLE	Average Idle Supply Current	X1=50MHz VIN=VCC/GND	-	-	mA
IDD	Static IDD Current	X1=Undriven	-	-	mA

9.1 DC CHARACTERISTIC

B. TTL Inputs, Outputs Tri-States

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Vil	Input Low Voltage	-	-	0.8	V
Vih	Input High Voltage		2.0	VCC+0.3	V
Iin	Input Current	VI=VCC/GND	-1.0	1.0	V
Voh	Minimum High Level Output Voltage (others/MII/Expansion)	Ioh=-2mA/ -4mA/ -8mA	2.4	-	V
Vol	Maximum Low Level Output Voltage (others/MII/Expansion)	Iol=2mA/ 4mA/ 8mA	-	0.4	V
Ioz	Maximum TRI-STATE Output Leakage Current	VOUT=VCC/ GND	-10.0	10.0	uA

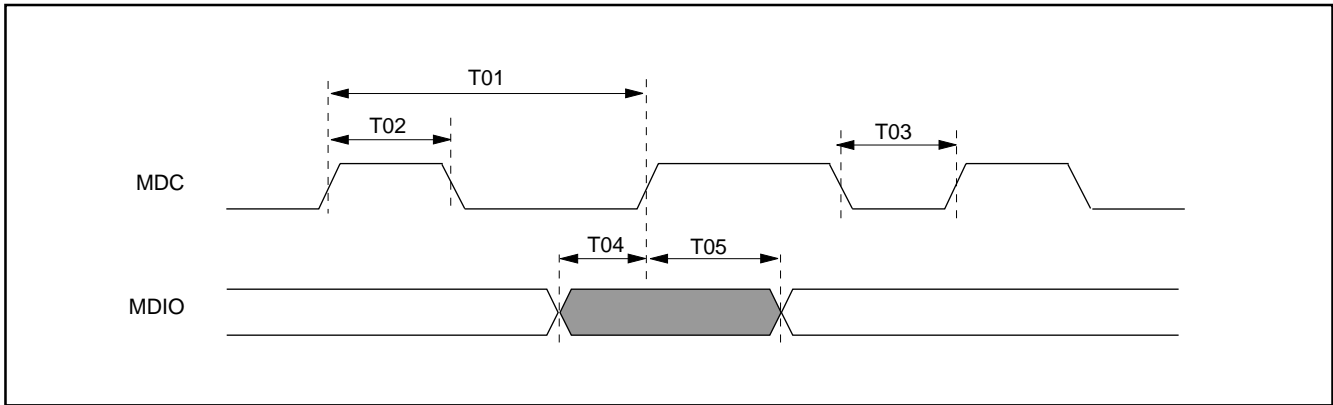
9.2 AC Characteristics
A.MII Management Interface


Figure 6-1 MDIO Timing Relationship to MDC

Symbol	Description	MIN.	MAX.	UNIT
T01	Period MDC	400	-	ns
T02	High Time for MDC	160	-	ns
T03	Low Time for MDC	160	-	ns
T04	MDIO Setup to MDC rising edge(sourced by STA)	10	-	ns
T05	MDIO Hold to MDC rising edge(sourced by STA)	10	-	ns
T05	MDIO to MDC rising edge (source by MX98748)	200	-	ns

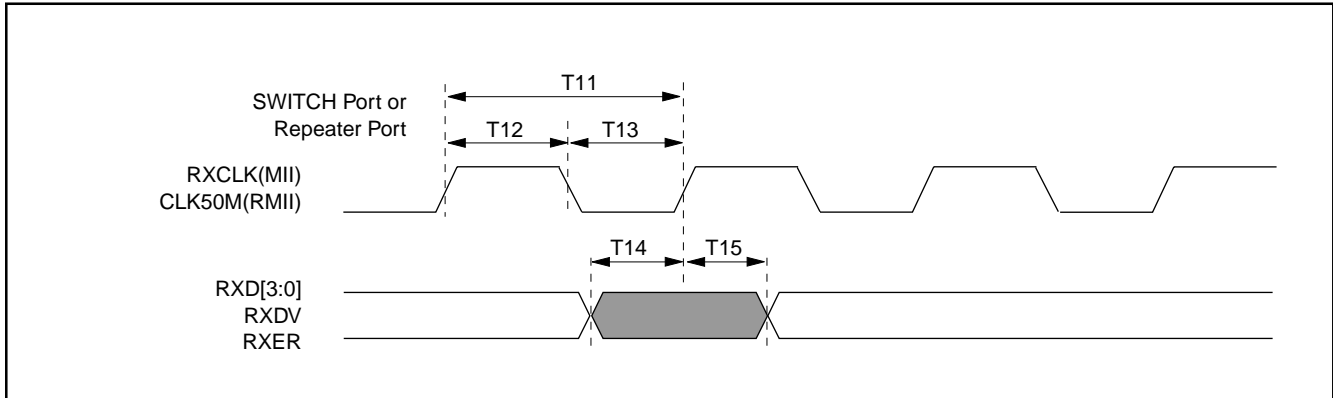
B.MII/RMII Interface


Figure 6-2 Receive Signal Timing Relationships at the MII/RMII

Symbol	Description(Include SWITCH & REPEATER Port)	MIN.	TYP.	MAX.	UNIT
T11	RECEIVE CLOCK Period in 100M(Note1)	39.998	40	40.002	ns
T11	RECEIVE CLOCK Period in 10M(Note1)	399.98	40	400.02	ns
T11	CLK50M Period(Note1)	19.999	20	20.001	ns
T12	RECEIVE CLOCK High Time	0.35*T11	-	-	ns
T13	RECEIVE CLOCK Low Time	0.35*T11	-	-	ns
T14	RXD[3:0]/RXDV/RXER Setup Time (MII Interface)	5	-	-	ns
T14	RXD[3:0]/RXDV/RXER Setup Time (RMII Interface Repeater Only)	2	-	-	ns
T15	RXD[3:0]/RXDV/RXER Hold Time(MII Interface)	5	-	-	ns
T15	RXD[3:0]/RXDV/RXER Hold Time (RMII Interface Repeater Only)	4	-	-	ns

Note 1: The accurate RECEIVE CLOCK frequency shall be 25MHz+/- 50ppm.
CLK50M should be 50MHz+/-50ppm.

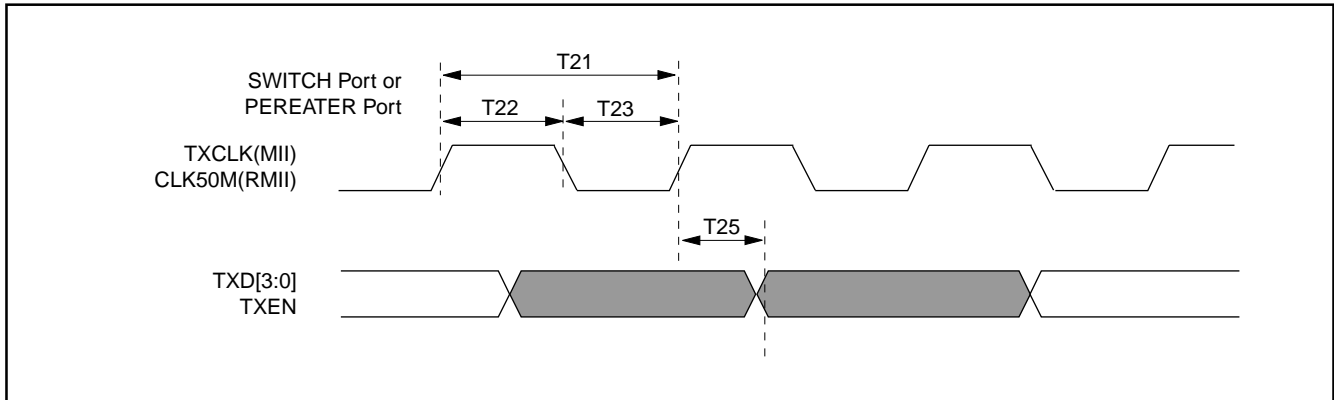


Figure 6-3 Transmit Signal Timing Relationships at the MII/RMII

Symbol	Description(Include SWITCH & REPEATER Port)	MIN.	TYP.	MAX.	UNIT
T21	TRANSMIT CLOCK Period in 100M(Note1)	39.998	40	40.002	ns
T21	TRANSMIT CLOCK Period in 10M(Note1)	39.998	40	40.002	ns
T21	CLK50M Period (Note1)	19.999	20	20.001	ns
T22	TRANSMIT CLOCK High Time	0.3*T21	-	-	ns
T23	TRANSMIT CLOCK Low Time	0.3*T21	-	-	ns
T24	TRANSMIT CLOCK to TXD[3:0]/TXEN Delay (MII Interface)	4	-	11	ns
T24	CLK50M to TXD[3:0]/TXEN Delay (RMII Interface Repeater Only)	4	-	11	ns

Note 1: The accurate TRANSMIT CLOCK frequency shall be 25MHz+/- 50ppm.
CLK50M should be 50MHz +/- 50ppm.

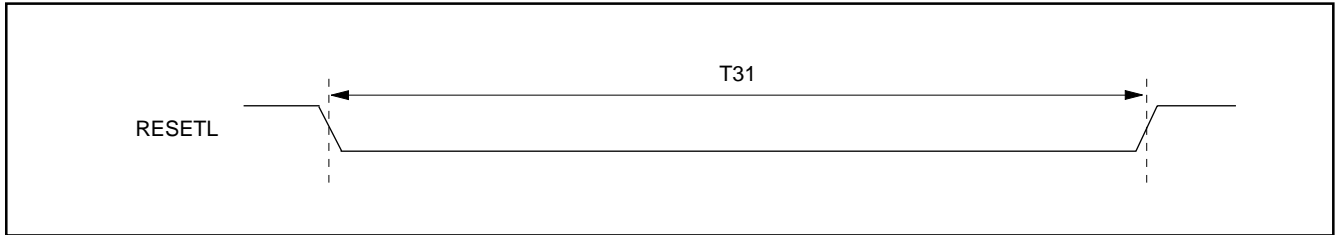
C. Power on Reset


Figure 6-6 Timing Constraint RESETL

Symbol	Description	MIN.	MAX.	UNIT
T31	Pulse Width for RESETL	1000	-	ns

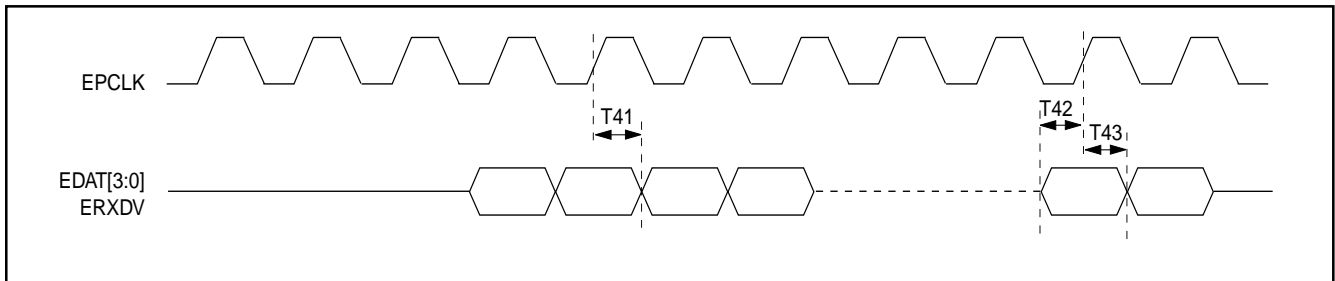
D. Expansion Port


Figure 6-11 EPCLK and EDAT Timing Relationship

Symbol	Description	MIN.	MAX.	UNIT
T41	EPCLK to EDAT delay time (100M bps) (EPCLK and EDAT outputed from MX98748)	19	21	ns
T41	EPCLK to EDAT delay time(10M bps) (EPCLK and EDAT outputed from MX98748)	199	201	ns
T42	EDAT/ERXDV Sepup Time (Input to MX98748)	5	-	ns
T43	EDAT/ERXDV Hold Time (Input to MX98748)	5	-	ns

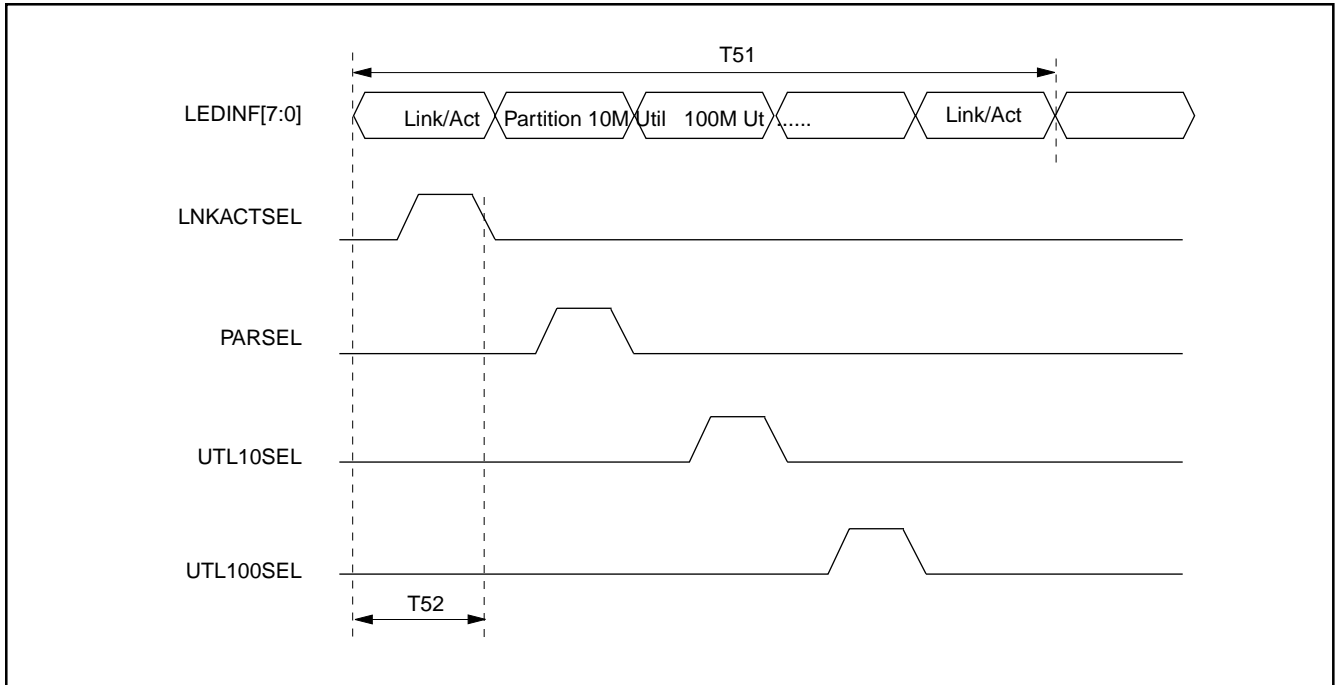
E.LED Display


Figure 6-12 Timing Relationship for LED Display

Symbol	Description	Typ.	UNIT
T51	Multiplexed LEDINF Period	40	ms
T52	Latch Clock Period	8	ms

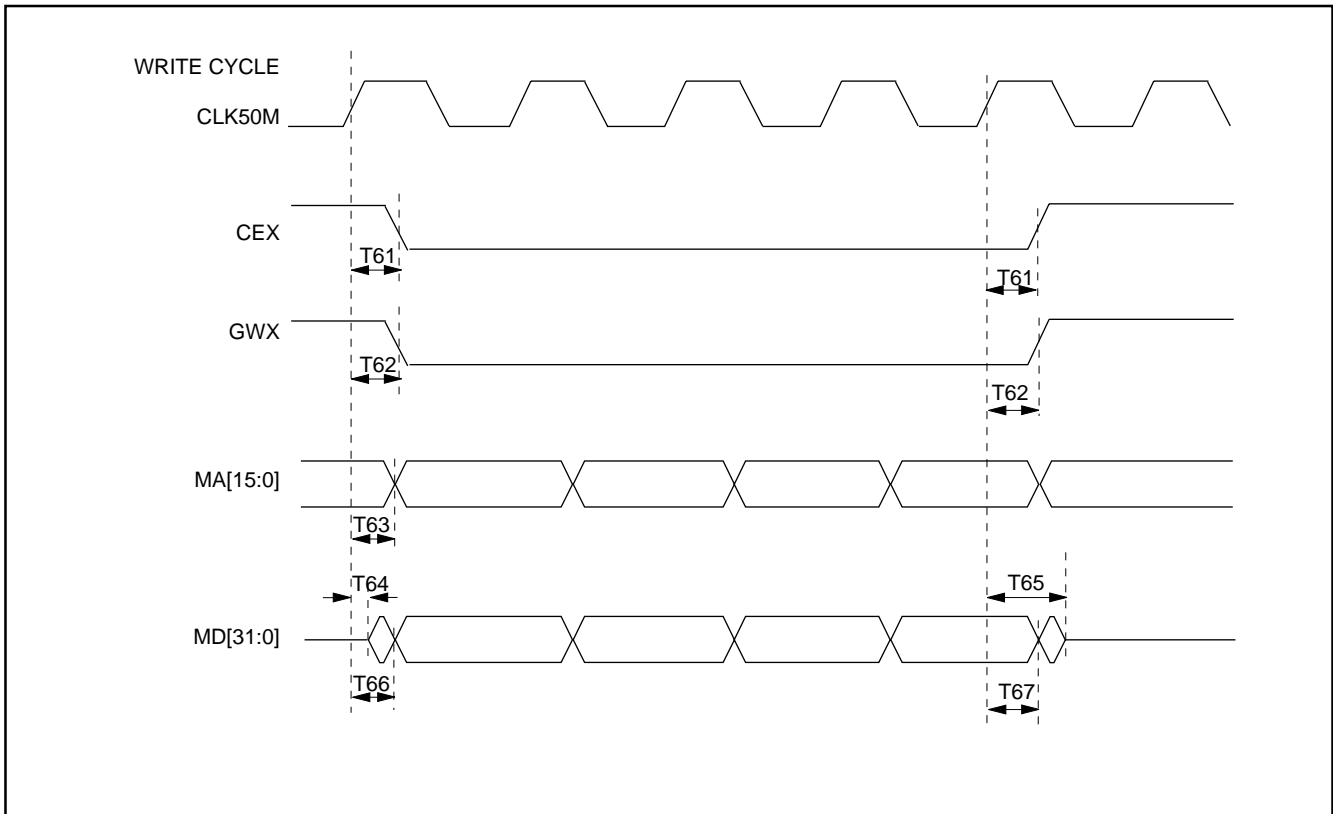
F.SSRAM Interface


Figure 6-12 Timing Relationship for SSRAM Interface(WRITE Cycle)

Symbol	Description	MIN.	MAX.	UNIT
T61	CLK50M to CEX Change	3.5	10.5	ns
T62	CLK50M to GWX Change	3.5	10.5	ns
T63	CLK50M to MA Valid	2.5	12.5	ns
T64	CLK50M to MD Low Z	3.5	8	ns
T65	CLK50M to MD High Z	3.5	8	ns
T66	CLK50M to MD Valid	3.5	15	ns
T67	CLK50M to MD Invalid	3.5	-	ns

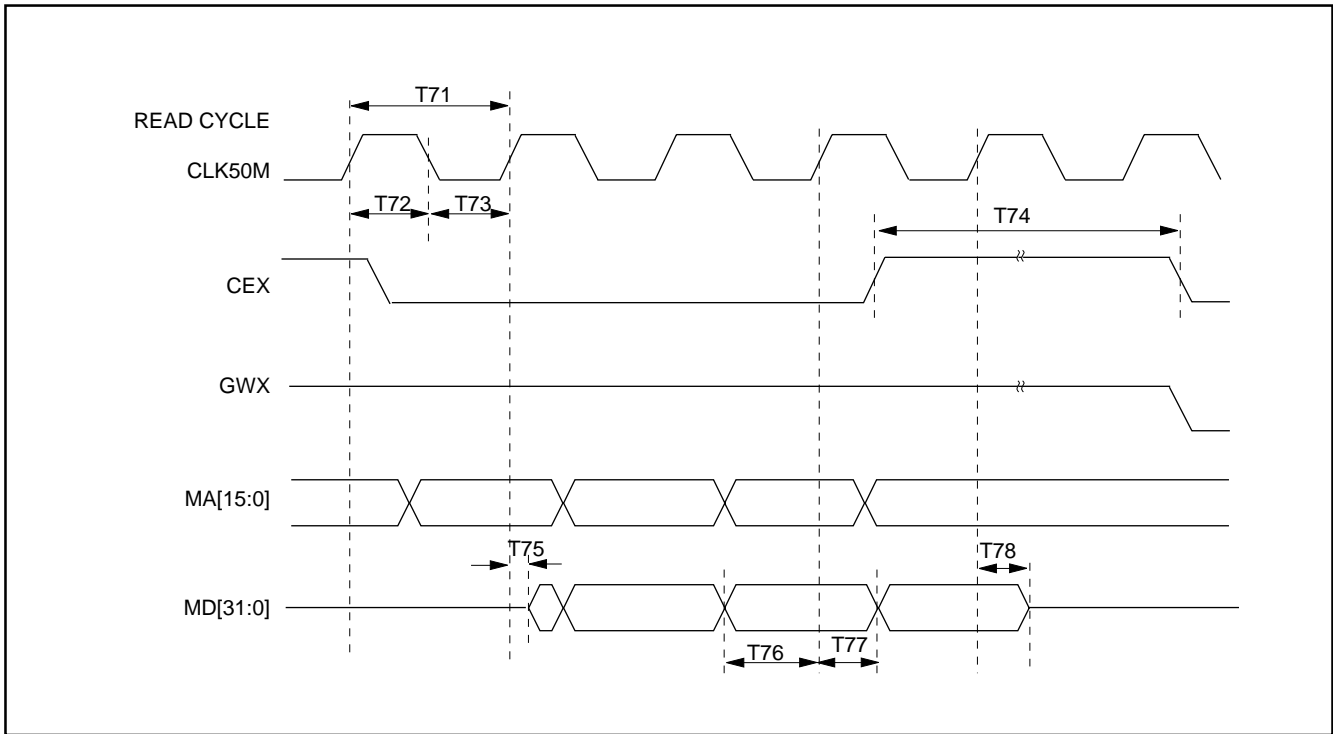


Figure 6-12 Timing Relationship for SSRAM Interface(READ Cycle)

Symbol	Description	MIN.	MAX.	UNIT
T71	CLK50M Cycle Time	20	-	ns
T72	CLK50M High Pulse Width	7	-	ns
T73	CLK50M Low Pulse Width	7	-	ns
T74	RAED to WRITE Width	40	-	ns
T75	CLK50M to MD Low Z	0	-	ns
T76	MD Setup Time	0	-	ns
T77	MD Hold Time	1.5	-	ns
T78	CLK50M to MD High Z	-	23	ns

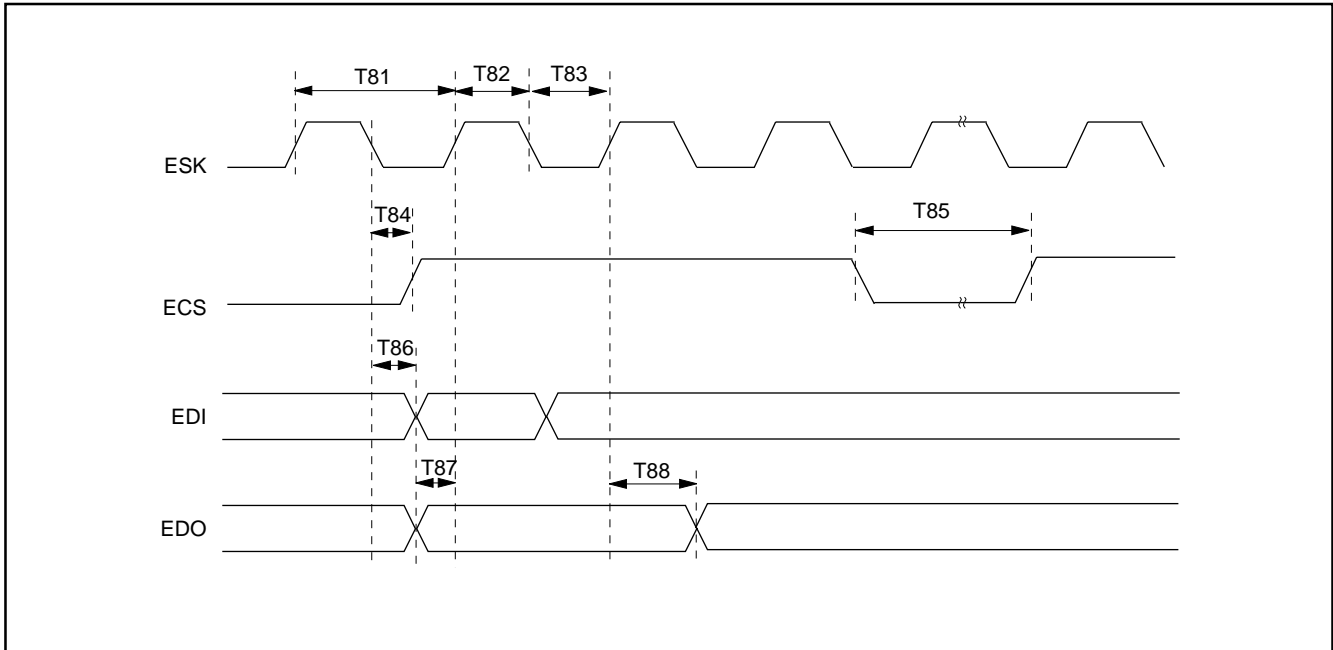
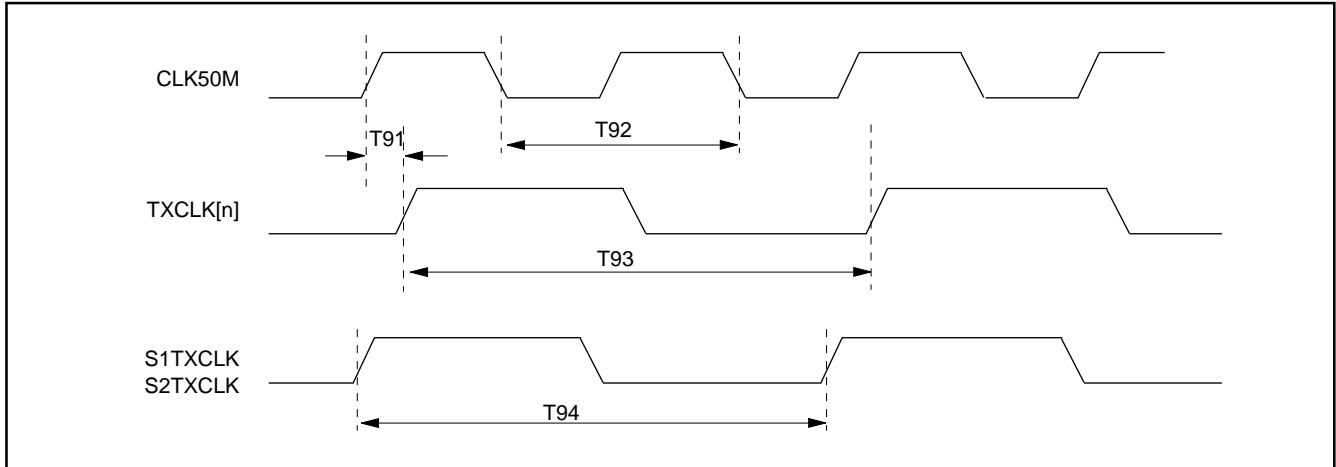
G. EEPROM Interface



Figure 6-12 Timing Relationship for EEPROM Interface

Symbol	Description	MIN.	Typ.	MAX.	UNIT
T81	ESK Cycle Time	-	1280	-	ns
T82	ESK High Pulse Width	-	640	-	ns
T83	ESK Low Pulse Width	-	640	-	ns
T84	ESK Low to ECS Change	-	-	3	ns
T85	ECS Low Width	2560	-	-	ns
T86	ESK Low to EDI Change	-	-	4	ns
T87	EDO Setup Time	5	-	-	ns
T88	EDO Hold Time	1	-	-	ns

H. CLOCK Input


Symbol	Description	MIN.	TYP.	MAX.	UNIT
T91	CLK50M to TXCLK[n] Time Interval in MII Mode	6	-	-	ns
T92	CLK50M Period	19.999	20	20.001	ns
T93	TXCLK[n] Period in 100M	39.998	40	40.002	ns
T93	TXCLK[n] Period in 10M	399.98	400	400.02	ns
T94	S1TXCLK, S2TXCLK Period in 100M	39.998	40	40.002	ns
T94	S1TXCLK, S2TXCLK Period in 10M	399.98	400	400.02	ns

10.PACKAGE INFORMATION

REF	UNIT	TITLE
		 Merritt International Co., Ltd
		REV. 0

REVISION HISTORY

Revision	Description	Page	Date
0.1	Correct mistyping Modify A/C waveform		JUN/22/1999
0.2	Add Typical Application Update MII management interface Update MII/RMII interface(receive Transmit) Add clock input waveform	P2 P21 P22 P29	JUN/17/1999
0.3	Correct mistyping Add Package Information Modify EEPROM Interface T81:1024-->1280;T82:512-->640; T83:512-->640;T85:2048-->2560	P1,6-16 P30 P28	AUG/20/1999



MX98748

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